# Advance Information

# High Speed, High Gain Bipolar NPN Power Transistor with Integrated Collector-Emitter Diode and Built-in Efficient Antisaturation Network for 1600 V Applications

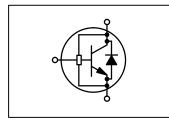
The MJE18604D2 is state—of—art High Speed High gain BIPolar transistor (H2BIP). Tight dynamic characteristics and lot to lot low spread ( $\pm 150$  ns on storage time) make it ideally suitable for light ballast applications. Therefore, there is no more a need to guarantee an hfe window.

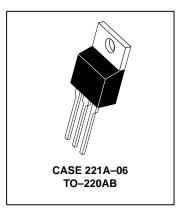
## Main features:

- Low Base Drive Requirement
- High DC Current Gain (30 Typical) @ IC = 400 mA
- Extremely Low Storage Time Min/Max Guarantees Due to the Internal Active Antisaturation (H2BIP) Structure which Minimizes the Spread
- Integrated Collector–Emitter Free Wheeling Diode Matched with the Power Transistor
- Fully Characterized and Guaranteed Dynamic VCE(sat)
- "6 Sigma" Process Providing Tight and Reproductible Parameter Spreads

# MJE18604D2

POWER TRANSISTORS
3 AMPERES
1600 VOLTS
100 WATTS





# **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector–Emitter Breakdown Voltage	VCEO	800	Vdc
Collector–Emitter Sustaining Voltage @ R = 200 $\Omega$	VCER	800	Vdc
Collector–Base Breakdown Voltage	V <sub>СВО</sub>	1600	Vdc
Collector–Emitter Breakdown Voltage	VCES	1600	Vdc
Emitter-Base Voltage	VEBO	12	Vdc
Collector Current — Continuous — Peak (1)	IC ICM	3 8	Adc
Base Current — Continuous — Peak (1)	I <sub>B</sub> I <sub>BM</sub>	2 4	Adc
*Total Device Dissipation @ T <sub>C</sub> = 25°C *Derate above 25°C	PD	100 0.8	Watt W/°C
Operating and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to 150	°C

# THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case — Junction to Ambient	R <sub>ÐJC</sub> R <sub>ÐJA</sub>	1.25 62.5	°C/W	
Maximum Lead Temperature for Soldering Purposes: 1/8" from case for 5 seconds	TL	260	°C	

<sup>(1)</sup> Pulse Test: Pulse Width = 5 ms, Duty Cycle ≤ 10%.

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# MJE18604D2

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Characteristic			Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						•	•	•
Collector–Emitter Sustaining Voltage (I <sub>C</sub> = 100 mA, L = 25 mH, R <sub>BE</sub> = 200 $\Omega$ )				VCER(sus)	800			Vdc
Collector–Base Breakdow (I <sub>CBO</sub> = 1 mA)	n Voltage			V <sub>СВО</sub>	1600			Vdc
Emitter–Base Breakdown (I <sub>EBO</sub> = 1 mA)	Voltage			VEBO	12	14		Vdc
Collector Cutoff Current (VCBO = Rated VCBO,	I <sub>B</sub> = 0)			ICBO			100	μAdc
Collector Cutoff Current (\)	$V_{CE} = Rated V_{CES}$ , $V_{CE} = 1300 V, V_{EB}$		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C @ T <sub>C</sub> = 125°C	ICES			100 1000 100	μAdc
Emitter–Cutoff Current (V <sub>EB</sub> = 11 Vdc, I <sub>C</sub> = 0)	02 12	,		IEBO			500	μAdc
ON CHARACTERISTICS								
Base–Emitter Saturation V ( $I_C = 0.5 \text{ Adc}$ , $I_B = 0.1 \text{ A}$	0		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	VBE(sat)		0.8 0.6	1.1 1	Vdc
(I <sub>C</sub> = 1 Adc, I <sub>B</sub> = 0.1 Ad	c)		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C			0.8	1 1	-
$(I_C = 2 \text{ Adc}, I_B = 0.4 \text{ Ad})$	c)		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C			0.9 0.8	1.2 1.1	
Collector–Emitter Saturation Voltage (I <sub>C</sub> = 250 mAdc, I <sub>B</sub> = 25 mAdc)			@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	VCE(sat)		1 1.7	1.25	Vdc
$(I_C = 0.5 \text{ Adc}, I_B = 50 \text{ m})$	Adc)		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	]		2.1 4	2.4	1
$(I_C = 0.8 \text{ Adc}, I_B = 80 \text{ m})$	Adc)		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C			3.7	5	
DC Current Gain (I <sub>C</sub> = 0.4 Adc, V <sub>CE</sub> = 3 '	DC Current Gain (I <sub>C</sub> = 0.4 Adc, V <sub>CE</sub> = 3 Vdc)			hFE	20 6	10	40	_
$(I_C = 5 \text{ mAdc}, V_{CE} = 10)$	Vdc)		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	]	20 20	35 55		]
DYNAMIC SATURATION V	OLTAGE		•				. I	
Decreasis Octoortics	IC = 0.3 Adc	@ 1 μs	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	VCE(dsat)		4.7 9.3		V
Dynamic Saturation Voltage: Determined 1 μs and	$I_{B1} = 50 \text{ mA}$ $V_{CC} = 300 \text{ V}$	@ 3 μs	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C			2.6 5.4		
3 μs respectively after rising I <sub>B1</sub> reaches	I <sub>C</sub> = 0.5 Adc	@ 1 μs	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C			9.7 18		
90% of final I <sub>B1</sub>	$I_{B1} = 50 \text{ mA}$ $V_{CC} = 300 \text{ V}$	@ 3 μs	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	]		6.4 12.3		1
DIODE CHARACTERISTIC	S	•		•		•	•	•
Forward Diode Voltage (I <sub>EC</sub> = 0.4 Adc)			@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	V <sub>EC</sub>		0.9 0.6	1.2	V
(I <sub>EC</sub> = 1 Adc)			@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C			1.05 0.7	1.5	
Forward Recovery Time (I <sub>F</sub> = 0.4 Adc, di/dt = 10 A/μs)			@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>fr</sub>		0.9 1.5		μs
$(I_F = 1.0 \text{ Adc, di/dt} = 10 \text{ A/}\mu\text{s})$			@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C			1.15 1.6		

# **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

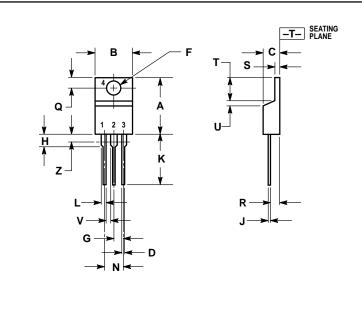
Characteristic			Symbol	Min	Тур	Max	Unit
DYNAMIC CHARACTER	RISTICS						
Current Gain Bandwidth (I <sub>C</sub> = 0.5 Adc, V <sub>CE</sub> =		f⊤		13		MHz	
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0	0, f = 1 MHz)		C <sub>ob</sub>		230	500	pF
Input Capacitance (VCE = 8 Vdc)			C <sub>ib</sub>		480	1000	pF
SWITCHING CHARACT	ERISTICS: Resistive Load (D	.C. ≤ 10%, Pulse Wid	th = 40 μs)				
Delay Time		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	<sup>t</sup> d		95 110	150	ns
Rise Time	I <sub>C</sub> = 0.5 Adc I <sub>B1</sub> = 66 mAdc	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>r</sub>		475 900	750	ns
Storage Time	I <sub>B2</sub> = 390 mAdc V <sub>CC</sub> = 125 V	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>S</sub>	400	910	700	ns
Fall Time		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>f</sub>		675 775	850	ns
Turn-on Time		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>on</sub>		440 570		ns
Storage Time	I <sub>C</sub> = 0.3 Adc I <sub>B1</sub> = 50 mAdc	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>S</sub>		4 5.9		μs
Fall Time	I <sub>B2</sub> = 50 mAdc V <sub>CC</sub> = 125 V	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>f</sub>		375 675		ns
Turn-off Time		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	<sup>t</sup> off		4.5 6.6		μs
Turn-on Time		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	ton		465 550	600	ns
Storage Time	I <sub>C</sub> = 0.3 Adc I <sub>B1</sub> = 50 mAdc	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>S</sub>	500	1800	800	ns
Fall Time	IB2 = 150 mAdc VCC = 125 V	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>f</sub>		800 550	1000	ns
Turn-off Time	7	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	toff		1.5 2.4	1.75	μs
Turn-on Time		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	ton		550 1300		ns
Storage Time	I <sub>C</sub> = 0.5 Adc I <sub>B1</sub> = 50 mAdc	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>S</sub>		4.35 5		μs
Fall Time	I <sub>B2</sub> = 50 mAdc V <sub>CC</sub> = 125 V	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>f</sub>		500 2000		ns
Turn-off Time		@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	toff		4.8 7		μs
Delay Time		@ T <sub>C</sub> = 25°C	t <sub>d</sub>		100	300	ns
Rise Time	I <sub>C</sub> = 0.5 Adc I <sub>B1</sub> = 50 mAdc	@ T <sub>C</sub> = 25°C	t <sub>r</sub>		300	800	ns
Storage Time	I <sub>B2</sub> = 250 mAdc	@ T <sub>C</sub> = 25°C	t <sub>S</sub>		1	1.2	μs
Fall Time	V <sub>CC</sub> = 125 V	@ T <sub>C</sub> = 25°C	t <sub>f</sub>		200	350	ns

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# **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

	Characteristic			Min	Тур	Max	Unit
WITCHING CHARACT	ERISTICS: Inductive Load (VC	C = 15 V)			•	•	
Fall Time	I <sub>C</sub> = 300 mAdc	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>f</sub>		170 210		ns
Storage Time	I <sub>B1</sub> = 50 mAdc I <sub>B2</sub> = 50 mAdc V <sub>7</sub> = 300 V	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>S</sub>		1.7 2.7		μѕ
Crossover Time	L <sub>C</sub> = 200 μH	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>C</sub>		150 400		ns
Fall Time	I <sub>C</sub> = 300 mAdc	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>f</sub>		160 150	250	ns
Storage Time	I <sub>B1</sub> = 50 mAdc I <sub>B2</sub> = 150 mAdc V <sub>7</sub> = 300 V	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>S</sub>	0.7	1.1	1	μѕ
Crossover Time	L <sub>C</sub> = 200 μH	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>C</sub>		160 160	250	ns
Fall Time	I <sub>C</sub> = 500 mAdc	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>f</sub>		165 700		ns
Storage Time	$I_{B1} = 50 \text{ mAdc}$ $I_{B2} = 50 \text{ mAdc}$ $V_Z = 300 \text{ V}$	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>S</sub>		3 4.1		μѕ
Crossover Time	L <sub>C</sub> = 200 μH	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>C</sub>		200 800		ns
Fall Time	IC = 500 mAdc	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>f</sub>		110 130	175	ns
Storage Time	I <sub>B1</sub> = 50 mAdc I <sub>B2</sub> = 250 mAdc V <sub>7</sub> = 300 V	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>S</sub>	0.7	1.8	1	μѕ
Crossover Time	L <sub>C</sub> = 200 μH	@ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 125°C	t <sub>C</sub>		130 250	200	ns

# **PACKAGE DIMENSIONS**



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
ø	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
J	0.000	0.050	0.00	1.27
٧	0.045		1.15	
7		0.080		2 04

- STYLE 1:
  PIN 1. BASE
  2. COLLECTOR
  3. EMITTER
  4. COLLECTOR

**CASE 221A-06** TO-220AB **ISSUE Y** 

# MJE18604D2

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